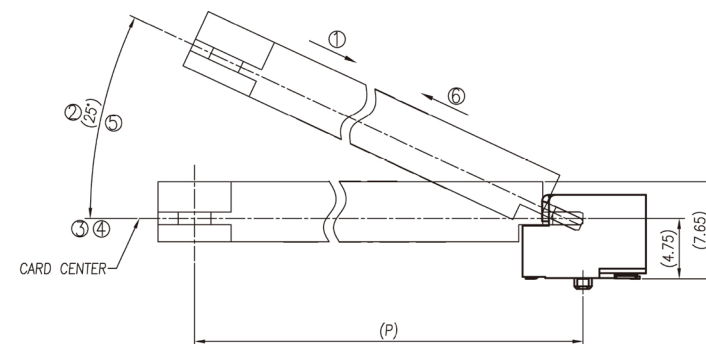
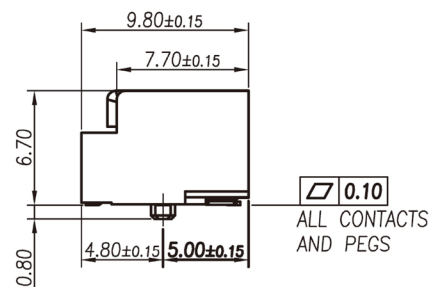
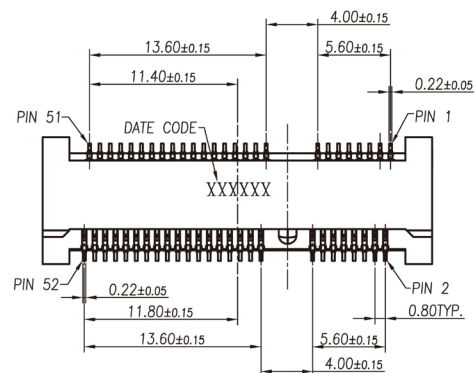


RoHS Compliant



MATING: ① INSERTING(25') → ② ROTATING → ③ FIXED
UNMATING: ④ UNFIXED → ⑤ ROTATING → ⑥ WITHDRAWING

NOTES:

1. MATERIAL:

HOUSING: THERMOPLASTIC , COLOR SEE NOTES 4
FLAME RESISTANCE UL94V-0.

CONTACTS: COPPER ALLOY, THICKNESS 0.20mm.

SOLDER PEGS: COPPER ALLOY, THICKNESS 0.2mm.

2. MSL LEVEL:

MSL(MOISTURE SENSITIVITY LEVELS)=1

3. FINISHED:

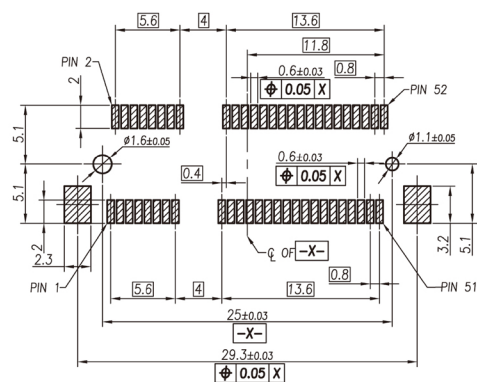
CONTACTS: GOLD PLATING ON CONTACT AREA AND
50u"~120u" MATTE TIN PLATING ON SOLDER AREA.

30u"~120u" NICKEL UNDER PLATING OVER ALL.

SOLDER PEGS: 50u"~120u" MATTE TIN PLATING OVER
50u"~120u" NICKEL UNDER PLATING OVER ALL.

TABLE1:

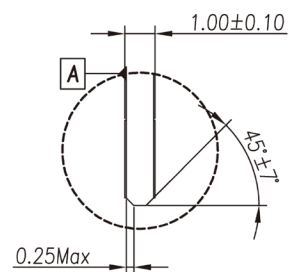
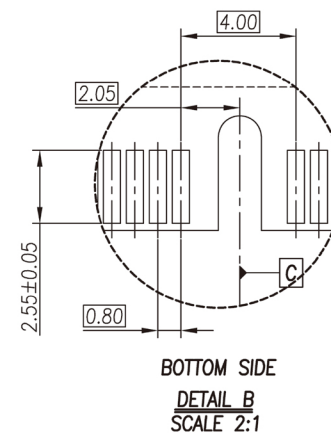
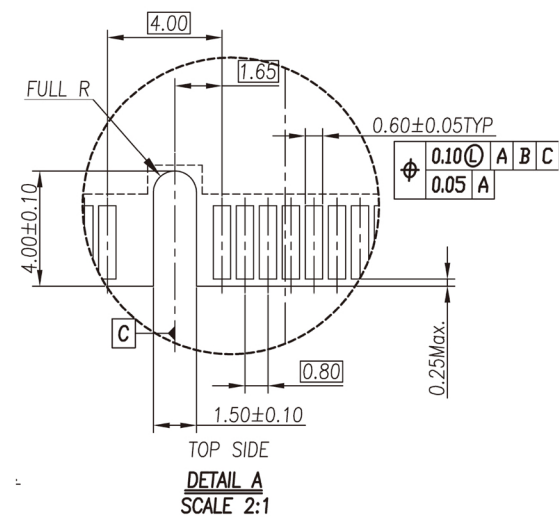
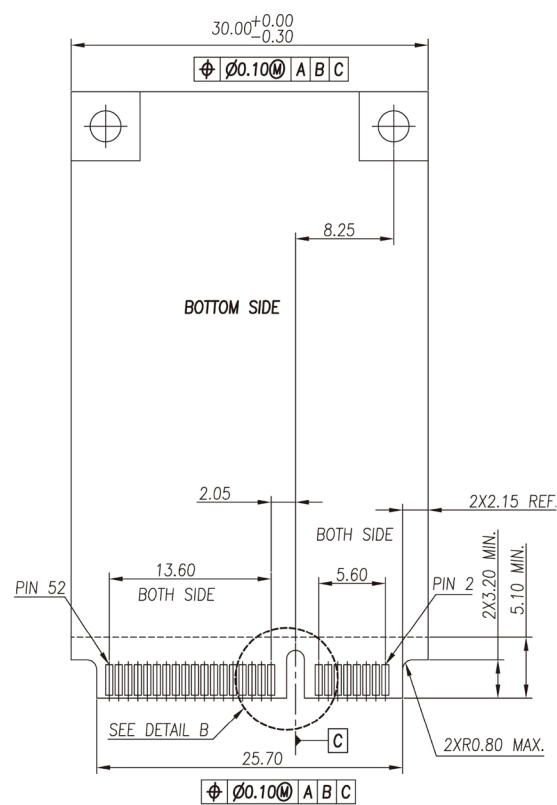
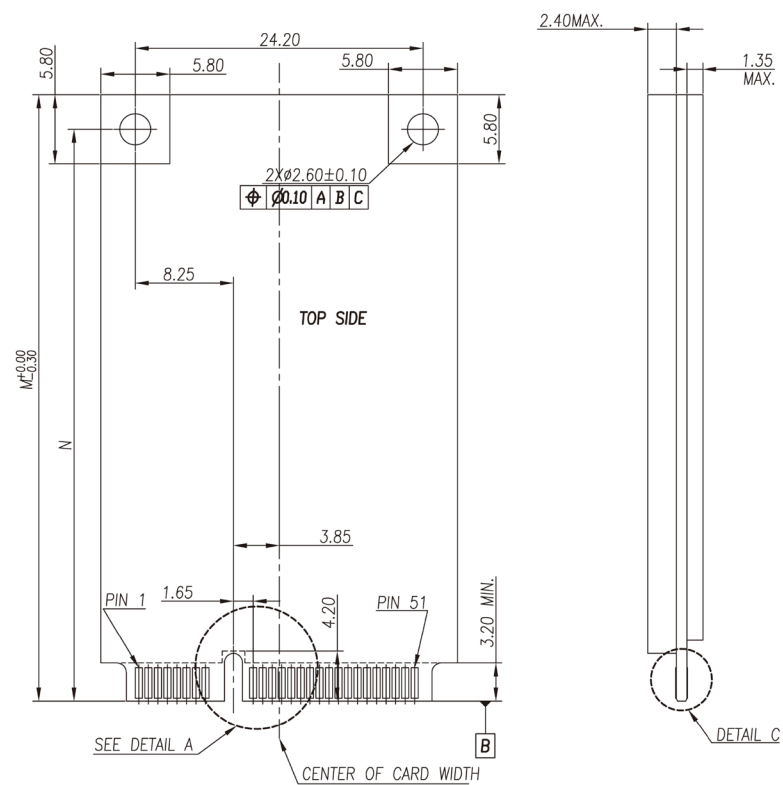
CONTACT AREA PLATING SPEC	HOUSING COLOR	PACKING
GOLD FLASH	BLACK	TAPE REEL



RECOMMEND PCB LAYOUT (MINIMUM THICKNESS OF THE PCB IS 0.8mm)
(OTHER TOLERANCES ARE NOT MARKED:±0.03)

深圳市敏连达科技有限公司 Shenzhen Minlianda Technology Co.,Ltd.			品名(ITEM NO)	MINI PCI-E 6.7H	
			料号(PART NO)	MLD-PCIE-52P-6.7H	
单位(UNIT): MM	未注公差 TOLERANCE UNSPECIFIED X.X ± 0.38 X.XX ± 0.20 X.XXX ± 0.10 X" ± 5" X.X" ± 2"	版次(REV): A/0	页次(PAGE):1/1	设计 (DESIGN)	柯南
比例(SCALE) 1:1		模号 (MODEL NO)		审核 (CHECKED)	邱敏
		图号 (DWG NO)		MLD-2509031032	核准(APPROVED)

RoHS Compliant



DETAIL C
SCALE 2:1

	M	N	P
FULL-MINI CARD	50.95	48.05	48.05
HALF-MINI CARD	26.8	23.9	23.9

深圳市敏连达科技有限公司 Shenzhen Minlianda Technology Co.,Ltd.			品名(ITEM NO)	MINI PCI-E 6.7H	
			料号(PART NO)	MLD-PCIE-52P-6.7H	
单位(UNIT): MM	未注公差 TOLERANCE UNSPECIFIED X.X ± 0.38 X.XX ± 0.20 X.XXX ± 0.10 X" ± 5" X.X" ± 2"	版次(REV): A/0	页次(PAGE):1/1	设计 (DESIGN)	柯南
比例(SCALE) 1:1		模号 (MODEL NO)		审核 (CHECKED)	邱敏
		图号 (DWG NO)		MLD-2509031032	核准(APPROVED)